EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

0603 Package Chip LED(0.6mm Height)

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version

Descriptions

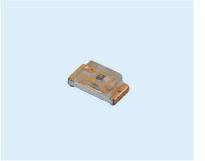
- The 19-213 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

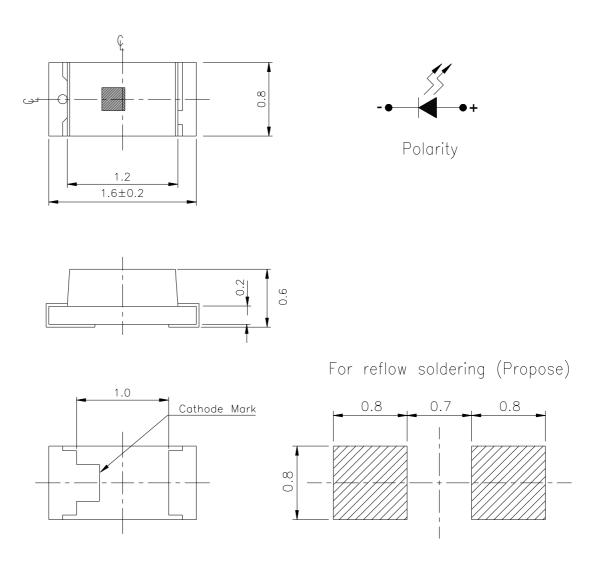
	C	I. C.L	
PART NO.	Material	Emitted Color	Lens Color
19-213/R6C-AP1Q2B/3T	AlGaInP	Brilliant Red	Water Clear



19-213/R6C-AP1Q2B/3T



Package Outline Dimensions



Note: Tolerances Unless Dimension is ± 0.1 mm ,Unit = mm

<u>19-213/R6C-AP1Q2B/3T</u>

<u>19-213/R6C-AP1Q2B/3T</u>

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	5	V	
Forward Current	$I_{\rm F}$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	45.0		112	mcd	
Viewing Angle	2 <i>θ</i> 1/2		120		deg	
Peak Wavelength	λp		632		nm	
Dominant Wavelength	λd	617.5		633.5	nm	IF=20mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm	
Forward Voltage	VF	1.75		2.35	V	
Reverse Current	Ir			10	μA	Vr=5V

Notes:

1.Tolerance of Luminous Intensity ±11 %

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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19-213/R6C-AP1Q2B/3T

Bin Range Of Dom. Wavelength

Groups	Bin	Min	Max	Unit	Condition	
A	E4	617.5	621.5			
	E5	621.5	625.5		I 20 A	
	E6	625.5	629.5	nm	IF=20mA	
	E7	629.5	633.5			

Bin Range Of Luminous Intensity

0	Ŭ				
Bin	Min	Max	Unit	Condition	
P1	45.0	57.0			
P2	57.0	72.0		I 2 0 A	
Q1	72.0	90.0	mcd	IF=20mA	
Q2	90.0	112.0			

Bin Range Of Forward Voltage

Groups	Bin	Min	Max	Unit	Condition	
В	0	1.75	1.95			
	1	1.95	2.15	V	IF=20mA	
	2	2.15	2.35			

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

Forward

Forward

50

40

30

25 20

10

1000

100

10

1

1.0

0.9

0.8

0.7

10

0 ∟ 1.2

19-213/R6C-AP1Q2B/3T

VS.

 $T_0 = 25^\circ$

Current

Voltage

2.0

1.6

f=1KHz Duty=1/10 2.4

Forward Voltage(Vp-volts

Luminous Intensity vs

Forward Current

 10^{1}

0.3

0.5

0.1

Forward Current

Radiation Diagram

Ô°

2.8

10²

10°

I_F(mA)

20°

Ta=25°

30°

40°

50°

60°

70°

80°

90°

0.6

3.0

Ta=25°

Spectrum Distribution Relative luminous intensity (%) Ta=25° 100 Forward Current $I_{\mathsf{F}}(\mathsf{mA})$ 75 50 25 0 500 550 600 650 700 Wavelength λ_p (nm) Luminous Intensity vs. Relative luminous intensity (%) Relative luminous intensity (%) Ambient Temperature 1000 100 10 1 -60 -40 -20 0 20 40 60 80 100 Ambient Temperature Ta(°C) Forward Current Derating Curve 50 Forward Current $I_{\rm F}\,({\rm mA})$ 40 30 25 20 10

Typical Electro-Optical Characteristics Curves

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Everlight Electronics Co., Ltd. Device No:SZDSE-193-R04

0 0

20

40

60

Ambient Temperature Ta(°C)

100

85

0.2

0.4

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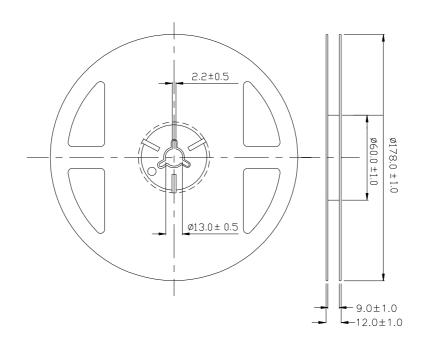
19-213/R6C-AP1Q2B/3T

Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



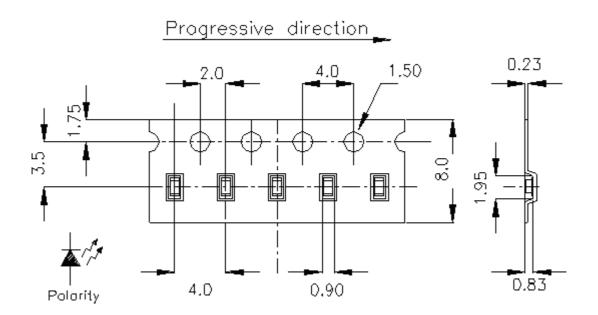
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm.

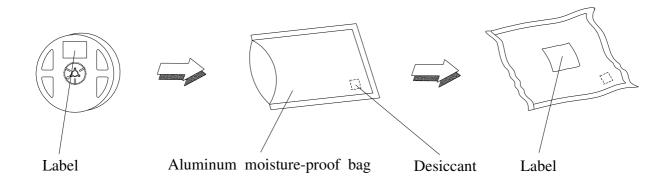
http://www.everlight.com Prepared date:13-Oct-2006

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

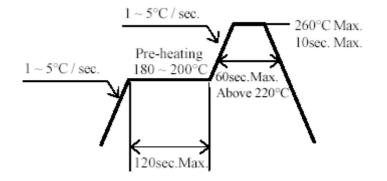
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-Free solder temperature profile



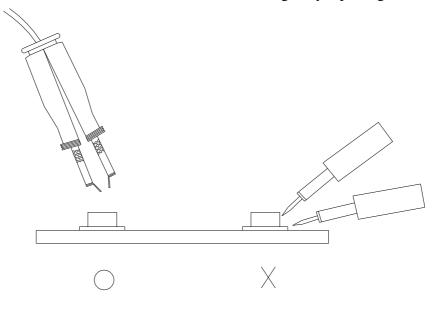
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C *Tel:* 886-2-2267-2000, 2267-9936 *Fax:* 886-2267-6244, 2267-6189, 2267-6306 *http://www.everlight.com*

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